

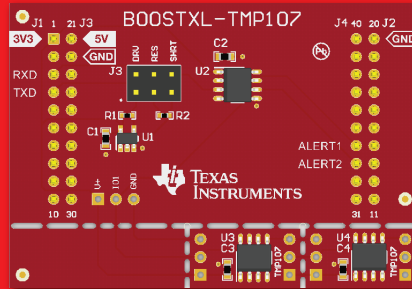
BoosterPack QuickStart Guide (QSG)



TI BoosterPack™

TMP107 plug-in module for the TI LaunchPad™ development ecosystem

PART NO: BOOSTXL-TMP107



BOOST
YOUR DESIGN

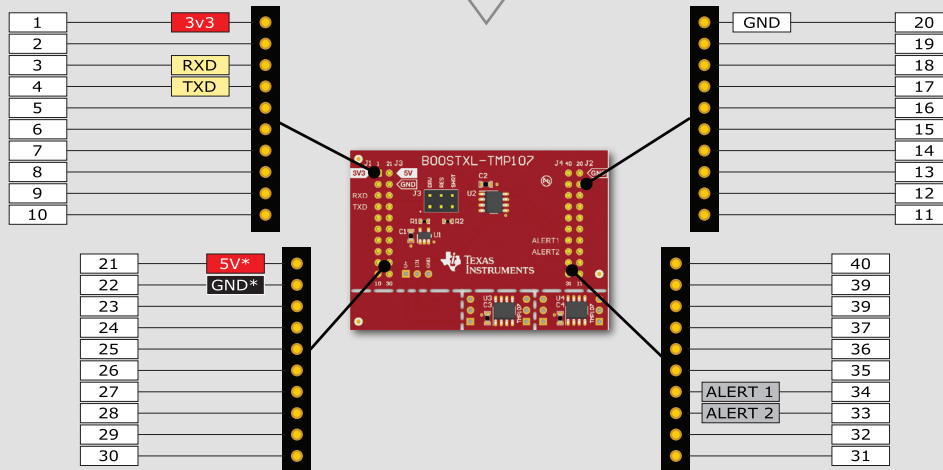
START @
ti.com/tool/boostxl-tmp107



TI BoosterPack™

TMP107 plug-in module for the TI LaunchPad™ development ecosystem

PART NO: BOOSTXL-TMP107



Explore all BoosterPack™ modules @ www.ti.com/boosterpacks

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